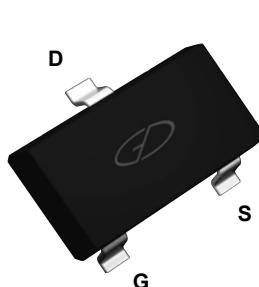
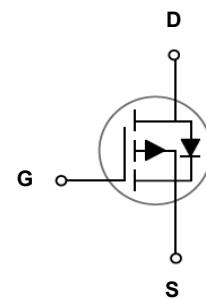


## Main Product Characteristics

BV <sub>DSS</sub>	-40V
R <sub>DS(ON)</sub>	68mΩ
I <sub>D</sub>	-2.9A



SOT-23



Schematic Diagram

## Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



## Description

The GSFC0403 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supply and a wide variety of other applications.

## Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Max.	Unit
Drain-Source Voltage	V <sub>DS</sub>	-40	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous ( $T_A=25^\circ\text{C}$ )	I <sub>D</sub>	-2.9	A
Drain Current-Continuous ( $T_A=100^\circ\text{C}$ )		-2.32	
Drain Current-Pulsed <sup>1</sup>	I <sub>DM</sub>	-11.6	A
Power Dissipation ( $T_A=25^\circ\text{C}$ )	P <sub>D</sub>	1	W
Power Dissipation-Derate above 25°C		8	W/°C
Thermal Resistance, Junction-to-Ambient	R <sub>θJA</sub>	125	°C/W
Operating Junction Temperature Range	T <sub>J</sub>	-55 To +150	°C
Storage Temperature Range	T <sub>STG</sub>	-55 To +150	°C

**Electrical Characteristics** ( $T_J=25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>On/Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=-250\mu\text{A}$	-40	-	-	V
Drain-Source Leakage Current	$\text{I}_{\text{DSS}}$	$\text{V}_{\text{DS}}=-40\text{V}, \text{V}_{\text{GS}}=0\text{V}, \text{T}_J=25^\circ\text{C}$	-	-	-1	$\mu\text{A}$
		$\text{V}_{\text{DS}}=-32\text{V}, \text{V}_{\text{GS}}=0\text{V}, \text{T}_J=125^\circ\text{C}$	-	-	-10	$\mu\text{A}$
Gate-Source Leakage Current	$\text{I}_{\text{GSS}}$	$\text{V}_{\text{GS}}=\pm20\text{V}, \text{V}_{\text{DS}}=0\text{V}$	-	-	$\pm100$	nA
Static Drain-Source On-Resistance	$\text{R}_{\text{DS(ON)}}$	$\text{V}_{\text{GS}}=-10\text{V}, \text{I}_D=-2\text{A}$	-	55	68	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=-4.5\text{V}, \text{I}_D=-1\text{A}$	-	75	100	
Gate Threshold Voltage	$\text{V}_{\text{GS(th)}}$	$\text{V}_{\text{GS}}=\text{V}_{\text{DS}}, \text{I}_D=-250\mu\text{A}$	-1.0	-1.65	-2.5	V
Forward Transconductance	$\text{g}_{\text{fs}}$	$\text{V}_{\text{DS}}=-10\text{V}, \text{I}_D=-1\text{A}$	-	3	-	S
<b>Dynamic and Switching Characteristics</b>						
Total Gate Charge <sup>2,3</sup>	$\text{Q}_g$	$\text{V}_{\text{DS}}=-32\text{V}, \text{I}_D=-2\text{A}, \text{V}_{\text{GS}}=-10\text{V}$	-	6.4	13	nC
Gate-Source Charge <sup>2,3</sup>	$\text{Q}_{\text{gs}}$		-	0.5	2	
Gate-Drain Charge <sup>2,3</sup>	$\text{Q}_{\text{gd}}$		-	2.7	6	
Turn-On Delay Time <sup>2,3</sup>	$\text{t}_{\text{d(on)}}$	$\text{V}_{\text{DD}}=-20\text{V}, \text{R}_G=6\Omega, \text{V}_{\text{GS}}=-10\text{V}, \text{I}_D=-1\text{A}$	-	12	24	nS
Rise Time <sup>2,3</sup>	$\text{t}_r$		-	9	20	
Turn-Off Delay Time <sup>2,3</sup>	$\text{t}_{\text{d(off)}}$		-	45	90	
Fall Time <sup>2,3</sup>	$\text{t}_f$		-	5	10	
Input Capacitance	$\text{C}_{\text{iss}}$	$\text{V}_{\text{DS}}=-25\text{V}, \text{V}_{\text{GS}}=0\text{V}, \text{F}=1\text{MHz}$	-	600	1200	pF
Output Capacitance	$\text{C}_{\text{oss}}$		-	60	120	
Reverse Transfer Capacitance	$\text{C}_{\text{rss}}$		-	43	80	
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Continuous Source Current	$\text{I}_s$	$\text{V}_G=\text{V}_D=0\text{V}, \text{Force Current}$	-	-	-2.9	A
Pulsed Source Current	$\text{I}_{\text{SM}}$		-	-	-5.8	A
Diode Forward Voltage	$\text{V}_{\text{SD}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_s=-1\text{A}, \text{T}_J=25^\circ\text{C}$	-	-	-1	V

Note:

1. Repetitive rating: Pulsed width limited by maximum junction temperature.
2. Pulse test: pulse width  $\leq 300\text{us}$ , duty cycle  $\leq 2\%$ .
3. Essentially independent of operation temperature.

## Typical Electrical and Thermal Characteristic Curves

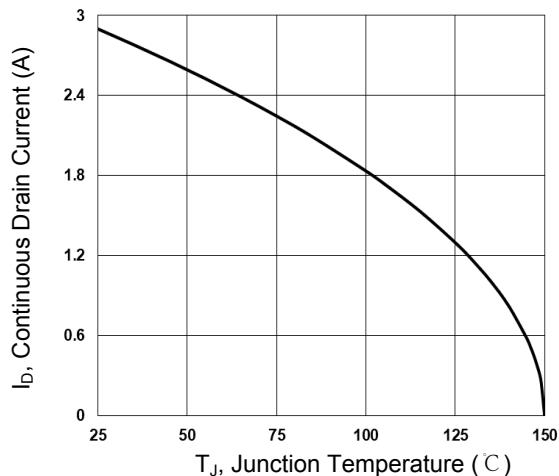


Figure 1. Continuous Drain Current vs. T<sub>J</sub>

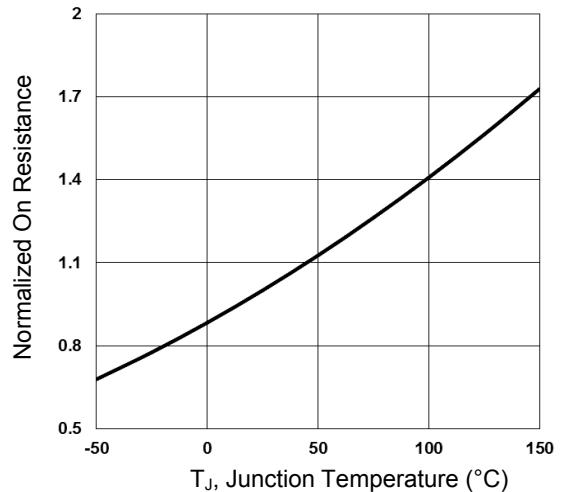


Figure 2. Normalized R<sub>DS(on)</sub> vs. T<sub>J</sub>

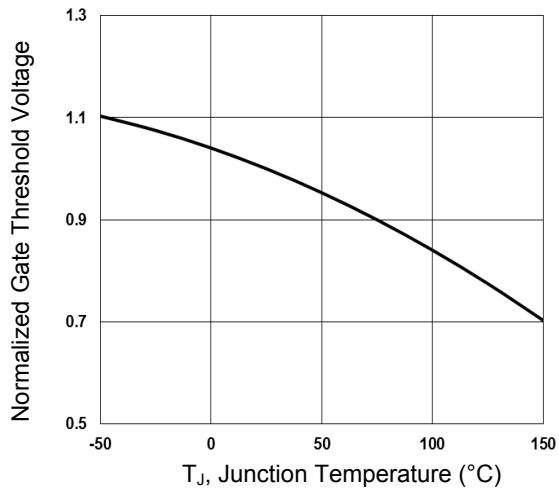


Figure 3. Normalized V<sub>th</sub> vs. T<sub>J</sub>

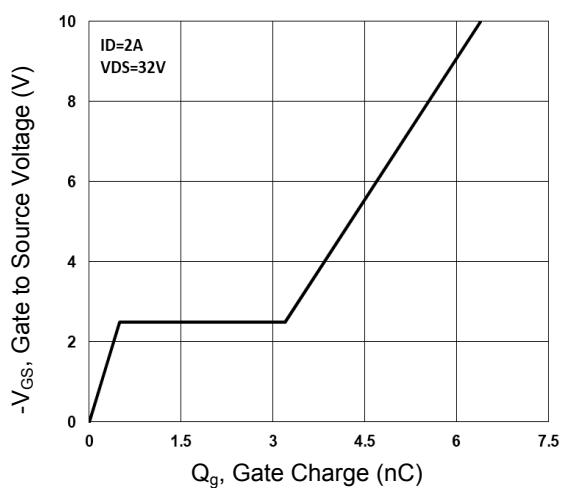


Figure 4. Gate Charge Waveform

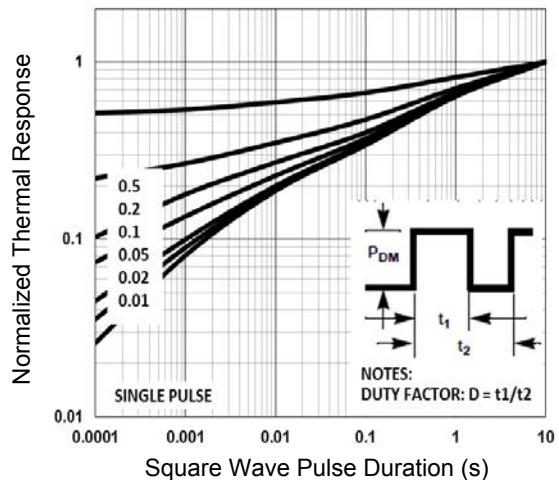


Figure 5. Normalized Transient Impedance

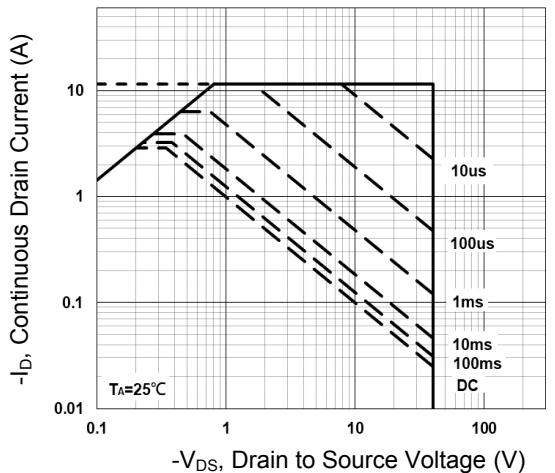


Figure 6. Maximum Safe Operation Area

### Typical Electrical and Thermal Characteristic Curves

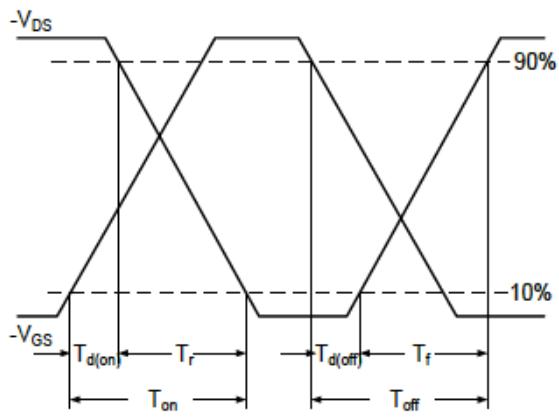


Figure 7. Switching Time Waveform

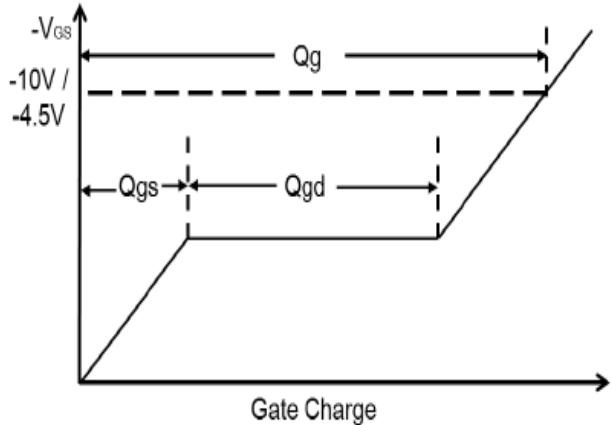
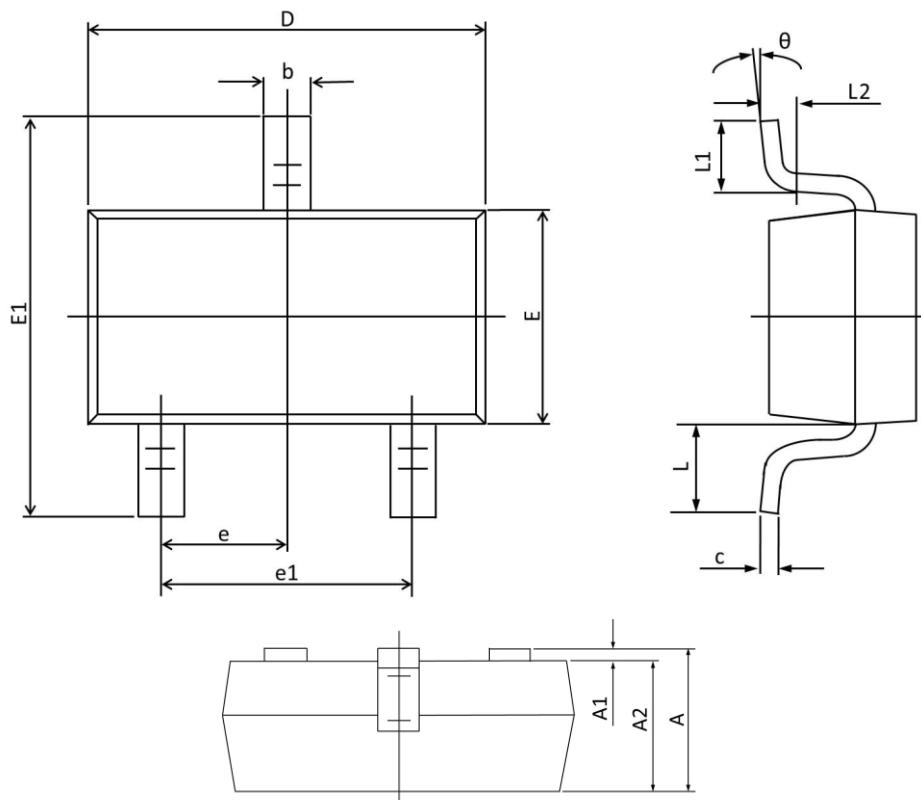


Figure 8. Gate Charge Waveform

### Package Outline Dimensions (SOT-23)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Max	Min	Max	Min
A	1.150	0.900	0.045	0.035
A1	0.100	0.000	0.004	0.000
A2	1.050	0.900	0.041	0.035
b	0.500	0.300	0.020	0.012
c	0.150	0.080	0.006	0.003
D	3.000	2.800	0.118	0.110
E	1.400	1.200	0.055	0.047
E1	2.550	2.250	0.100	0.089
e	0.95 TYP.		0.037 TYP.	
e1	2.000	1.800	0.079	0.071
L	0.55 REF.		0.022 REF.	
L1	0.500	0.300	0.020	0.012
L2	0.25 TYP.		0.01 TYP.	
θ	8°	0°	8°	0°